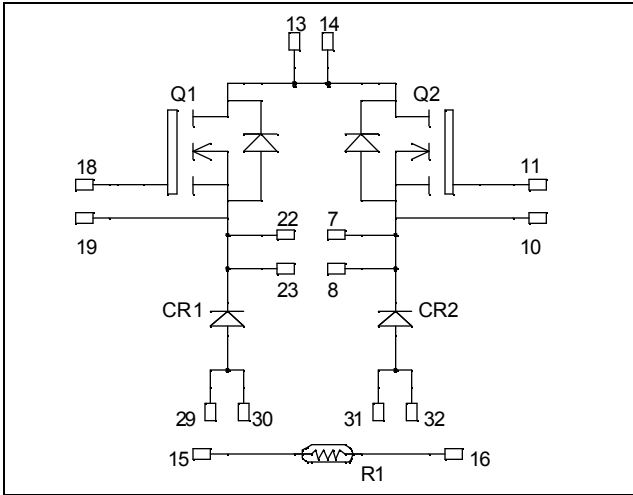


**Dual Buck chopper
MOSFET Power Module**

$V_{DSS} = 500V$
 $R_{DSon} = 65m\Omega \text{ max @ } T_j = 25^\circ C$
 $I_D = 51A \text{ @ } T_c = 25^\circ C$

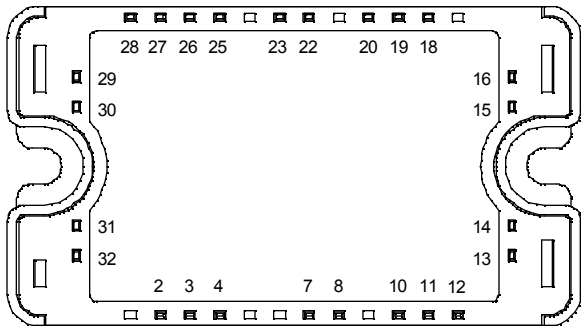


Application

- AC and DC motor control
- Switched Mode Power Supplies

Features

- Power MOS 7[®] MOSFETs
 - Low R_{DSon}
 - Low input and Miller capacitance
 - Low gate charge
 - Avalanche energy rated
 - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
 - Symmetrical design
- Internal thermistor for temperature monitoring
- High level of integration



Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- Each leg can be easily paralleled to achieve a single buck of twice the current capability

All multiple inputs and outputs must be shorted together
 Example: 13/14 ; 29/30 ; 22/23 ...

Absolute maximum ratings

| Symbol | Parameter | Max ratings | Unit |
|------------|---|--------------------|------------|
| V_{DSS} | Drain - Source Breakdown Voltage | 500 | V |
| I_D | Continuous Drain Current | $T_c = 25^\circ C$ | 51 |
| | | $T_c = 80^\circ C$ | 38 |
| I_{DM} | Pulsed Drain current | 204 | |
| V_{GS} | Gate - Source Voltage | ± 30 | V |
| R_{DSon} | Drain - Source ON Resistance | 65 | m Ω |
| P_D | Maximum Power Dissipation | $T_c = 25^\circ C$ | 390 |
| I_{AR} | Avalanche current (repetitive and non repetitive) | 51 | A |
| E_{AR} | Repetitive Avalanche Energy | 50 | mJ |
| E_{AS} | Single Pulse Avalanche Energy | 3000 | |

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

| Symbol | Characteristic | Test Conditions | Min | Typ | Max | Unit |
|--------------|----------------------------------|---|-----|-----|-----------|-----------|
| BV_{DSS} | Drain - Source Breakdown Voltage | $V_{GS} = 0V, I_D = 250\mu A$ | 500 | | | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{GS} = 0V, V_{DS} = 500V, T_j = 25^\circ\text{C}$ | | | 250 | μA |
| | | $V_{GS} = 0V, V_{DS} = 400V, T_j = 125^\circ\text{C}$ | | | 1000 | |
| $R_{DS(on)}$ | Drain - Source on Resistance | $V_{GS} = 10V, I_D = 25.5A$ | | | 65 | $m\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS} = V_{DS}, I_D = 2.5mA$ | 3 | | 5 | V |
| I_{GSS} | Gate - Source Leakage Current | $V_{GS} = \pm 30V, V_{DS} = 0V$ | | | ± 100 | nA |

Dynamic Characteristics

| Symbol | Characteristic | Test Conditions | Min | Typ | Max | Unit |
|--------------|------------------------------|---|-----|------|-----|---------|
| C_{iss} | Input Capacitance | $V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$ | | 7000 | | pF |
| C_{oss} | Output Capacitance | | | 1400 | | |
| C_{rss} | Reverse Transfer Capacitance | | | 90 | | |
| Q_g | Total gate Charge | $V_{GS} = 10V, V_{Bus} = 250V, I_D = 51A$ | | 140 | | nC |
| Q_{gs} | Gate - Source Charge | | | 40 | | |
| Q_{gd} | Gate - Drain Charge | | | 70 | | |
| $T_{d(on)}$ | Turn-on Delay Time | Inductive switching @ 125°C $V_{GS} = 15V, V_{Bus} = 333V, I_D = 51A, R_G = 3\Omega$ | | 21 | | ns |
| T_r | Rise Time | | | 38 | | |
| $T_{d(off)}$ | Turn-off Delay Time | | | 75 | | |
| T_f | Fall Time | | | 93 | | |
| E_{on} | Turn-on Switching Energy ① | Inductive switching @ 25°C $V_{GS} = 15V, V_{Bus} = 333V, I_D = 51A, R_G = 3\Omega$ | | 1035 | | μJ |
| E_{off} | Turn-off Switching Energy ② | | | 845 | | |
| E_{on} | Turn-on Switching Energy ① | Inductive switching @ 125°C $V_{GS} = 15V, V_{Bus} = 333V, I_D = 51A, R_G = 3\Omega$ | | 1556 | | μJ |
| E_{off} | Turn-off Switching Energy ② | | | 1013 | | |

Diode ratings and characteristics

| Symbol | Characteristic | Test Conditions | Min | Typ | Max | Unit |
|-------------|---|---|---------------------------|-----|-----|---------|
| V_{RRM} | Maximum Peak Repetitive Reverse Voltage | | 600 | | | V |
| I_{RM} | Maximum Reverse Leakage Current | $V_R = 600V$ | $T_j = 25^\circ\text{C}$ | | 250 | μA |
| | | | $T_j = 125^\circ\text{C}$ | | 750 | |
| $I_{F(AV)}$ | Maximum Average Forward Current | 50% duty cycle, $T_c = 70^\circ\text{C}$ | | 60 | | A |
| V_F | Diode Forward Voltage | $I_F = 60A$ | | 2.2 | 2.7 | V |
| | | $I_F = 120A$ | | 2.3 | | |
| | | $I_F = 60A, T_j = 125^\circ\text{C}$ | | 1.4 | | |
| t_{rr} | Reverse Recovery Time | $I_F = 60A, V_R = 400V, di/dt = 200A/\mu s$ | $T_j = 25^\circ\text{C}$ | | 55 | ns |
| | | | $T_j = 125^\circ\text{C}$ | | 151 | |
| Q_{rr} | Reverse Recovery Charge | $I_F = 60A, V_R = 400V, di/dt = 200A/\mu s$ | $T_j = 25^\circ\text{C}$ | | 121 | nC |
| | | | $T_j = 125^\circ\text{C}$ | | 999 | |

① E_{on} includes diode reverse recovery.

② In accordance with JEDEC standard JESD24-1.

Thermal and package characteristics

| Symbol | Characteristic | Min | Typ | Max | Unit | |
|-------------------|--|-------|-------------|------|------|-----|
| R _{thJC} | Junction to Case | IGBT | | 0.32 | °C/W | |
| | | Diode | | 0.9 | | |
| V _{ISOL} | RMS Isolation Voltage, any terminal to case t=1 min, I _{isol} <1mA, 50/60Hz | 2500 | | | V | |
| T _J | Operating junction temperature range | -40 | | 150 | °C | |
| T _{STG} | Storage Temperature Range | -40 | | 125 | | |
| T _C | Operating Case Temperature | -40 | | 100 | | |
| Torque | Mounting torque | | To heatsink | M4 | 4.7 | N.m |
| Wt | Package Weight | | | | 110 | g |

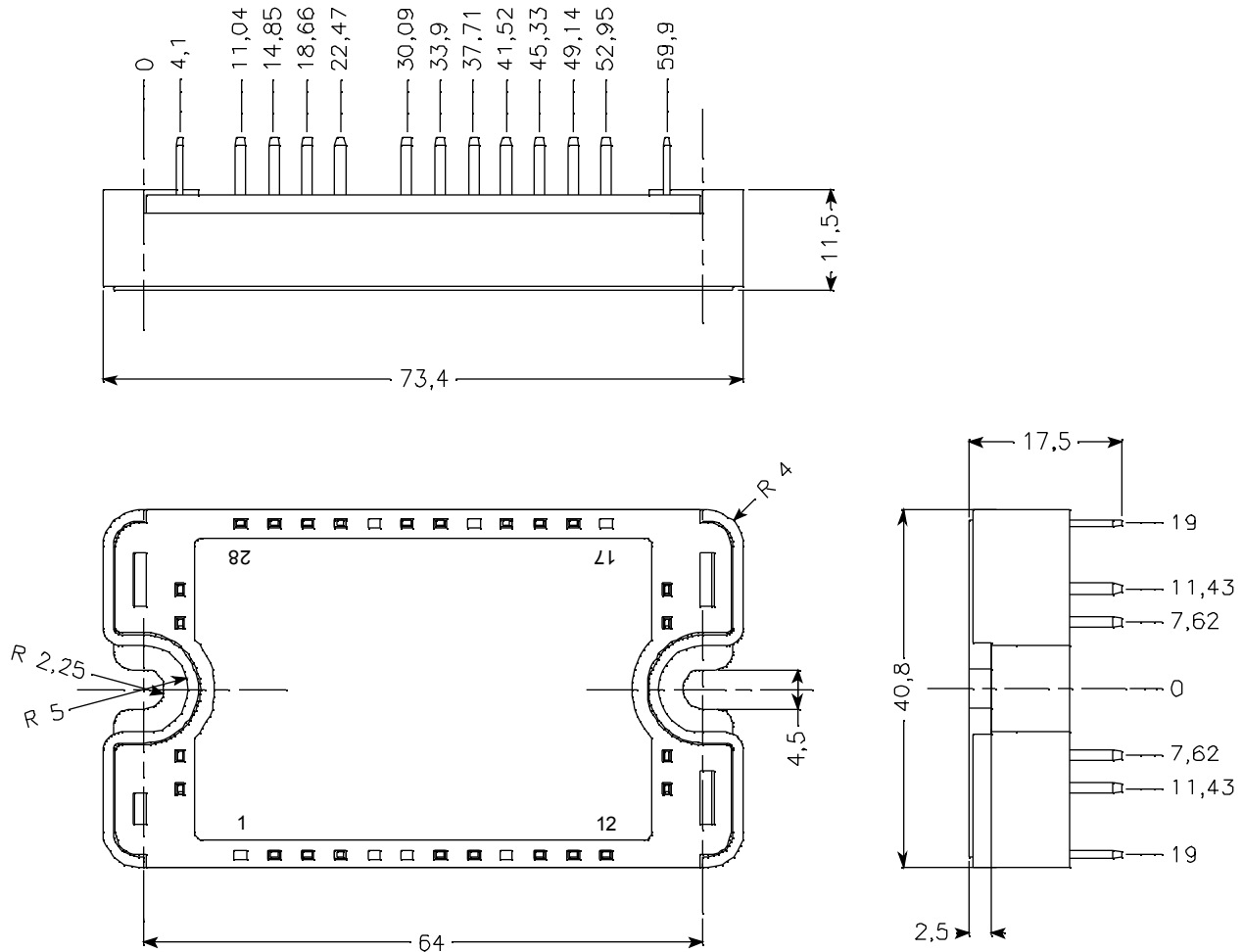
Temperature sensor NTC

| Symbol | Characteristic | Min | Typ | Max | Unit |
|--------------------|----------------------------|-----|------|-----|------|
| R ₂₅ | Resistance @ 25°C | | 68 | | kΩ |
| B _{25/85} | T ₂₅ = 298.16 K | | 4080 | | K |

$$R_T = \frac{R_{25}}{\exp \left[B_{25/85} \left(\frac{1}{T_{25}} - \frac{1}{T} \right) \right]}$$

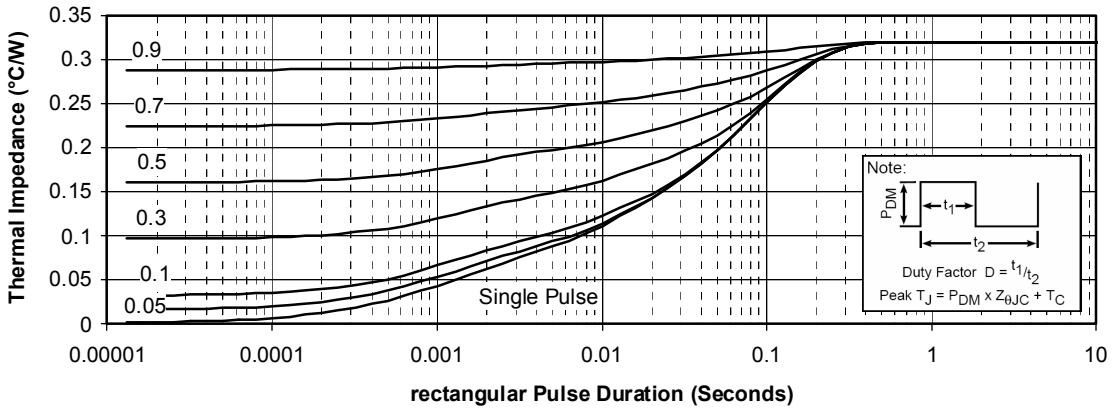
T: Thermistor temperature
R_T: Thermistor value at T

Package outline

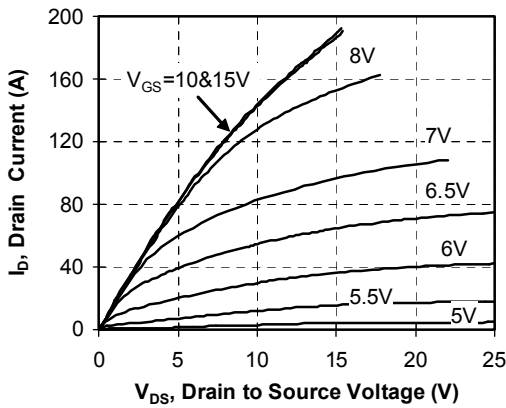


Typical Performance Curve

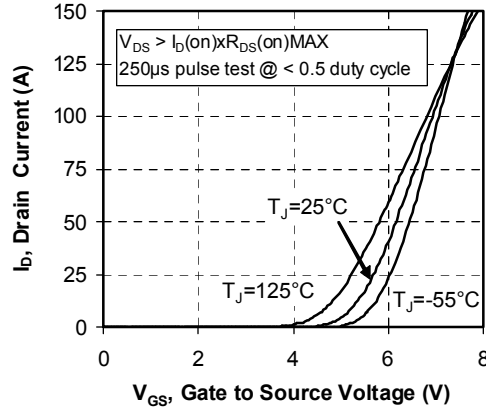
Maximum Effective Transient Thermal Impedance, Junction to Case vs Pulse Duration



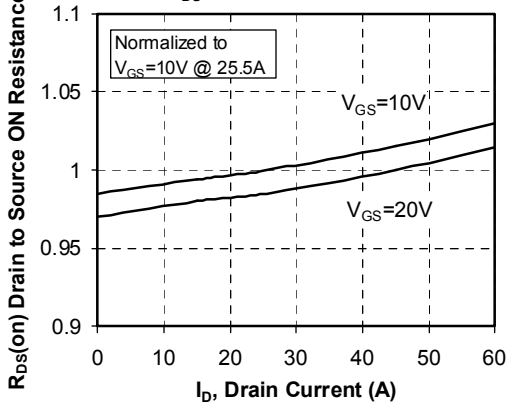
Low Voltage Output Characteristics



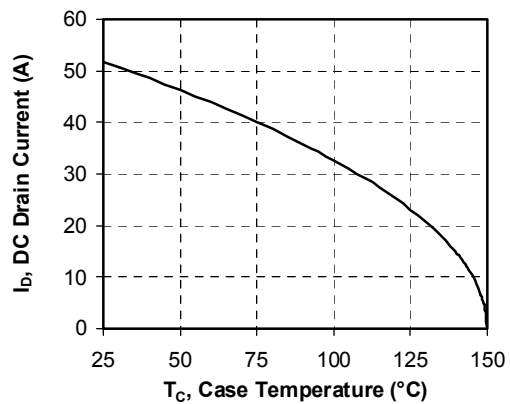
Transfer Characteristics



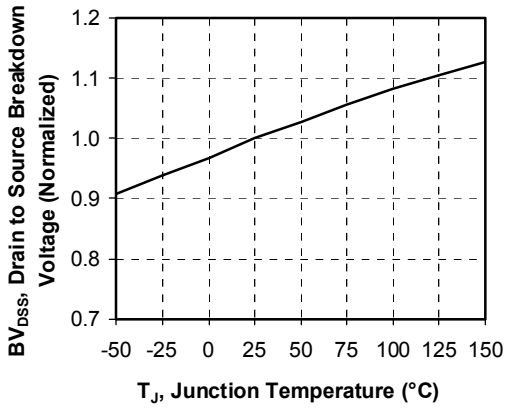
RDS(on) vs Drain Current



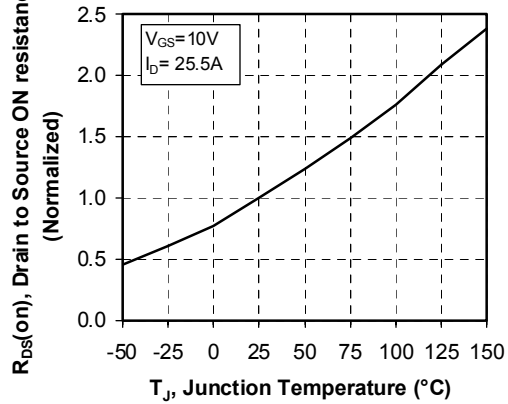
DC Drain Current vs Case Temperature



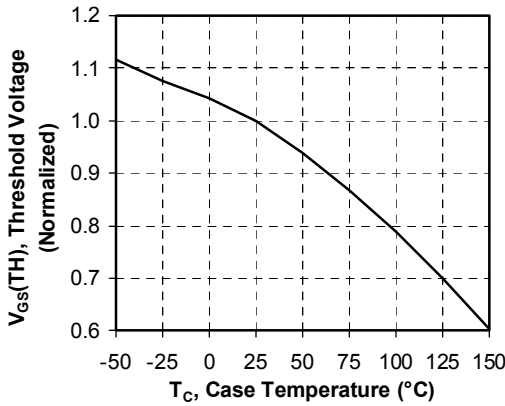
Breakdown Voltage vs Temperature



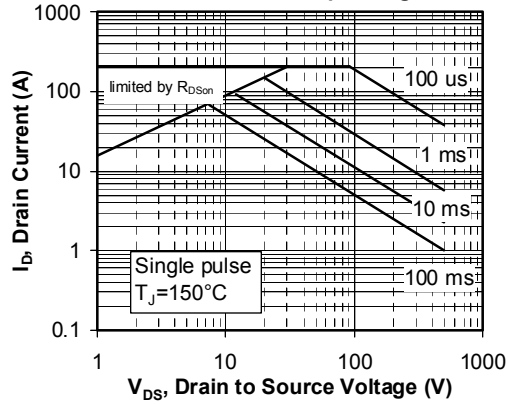
ON resistance vs Temperature



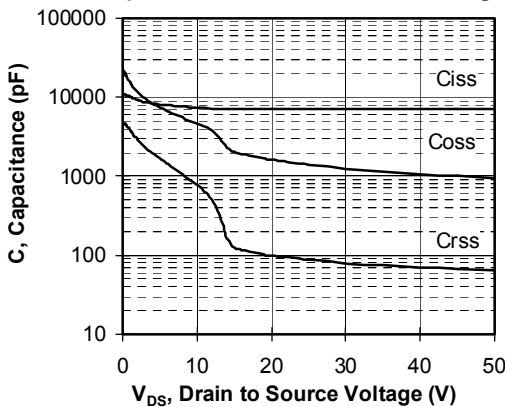
Threshold Voltage vs Temperature



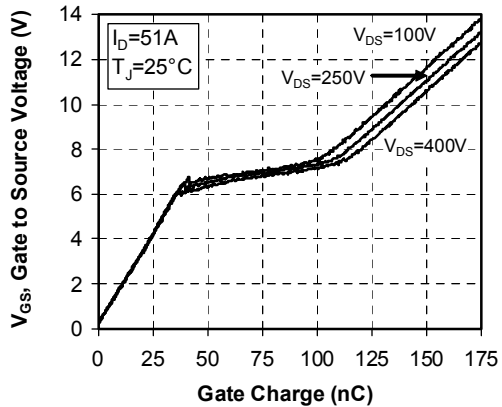
Maximum Safe Operating Area

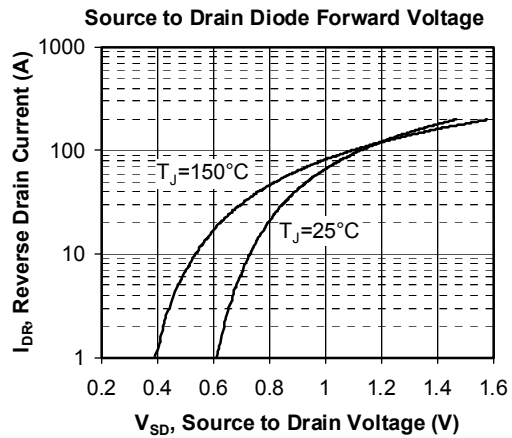
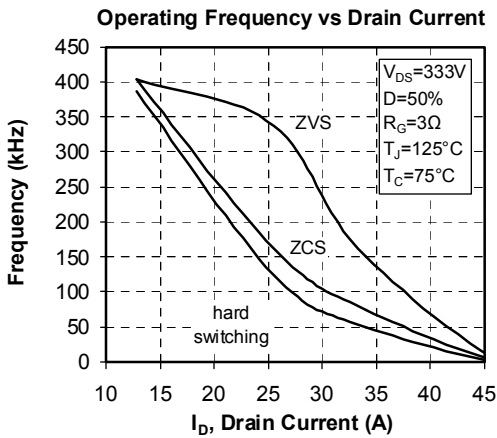
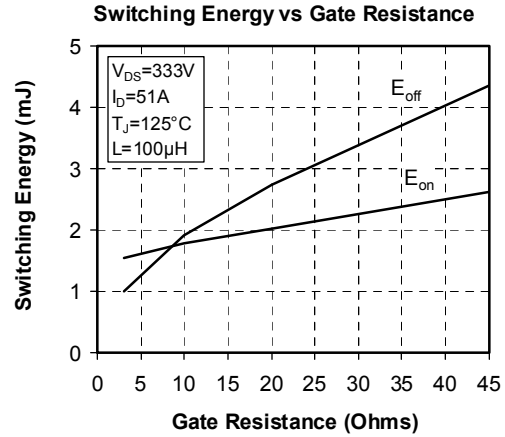
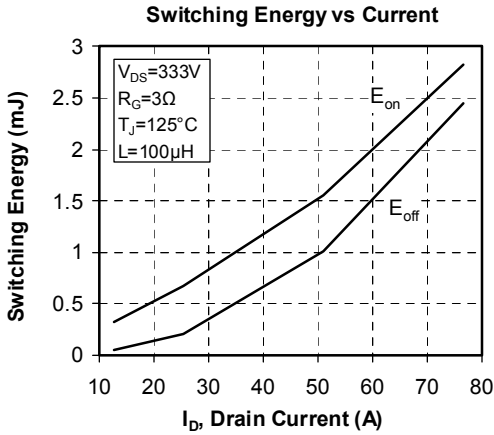
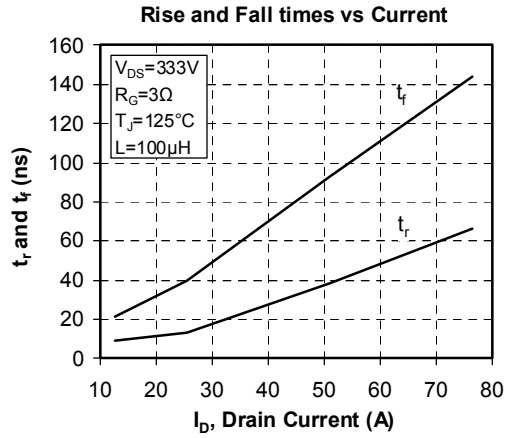
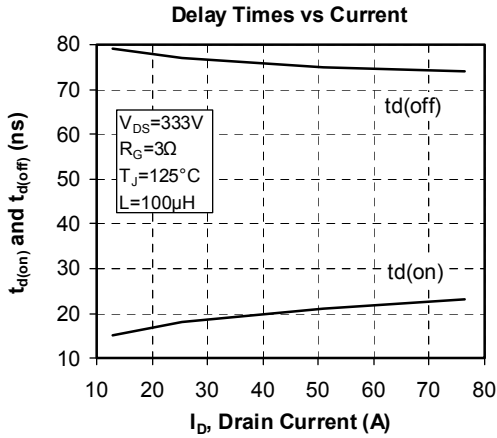


Capacitance vs Drain to Source Voltage



Gate Charge vs Gate to Source Voltage





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